

SIM CARD CONNECTORS QUICK REFERENCE GUIDE

SIM (Subscriber Identity Module) and UIM (Universal Identity Module) cards are widely used in a variety of mobile applications, including, billing, security and number storage purposes in mobile devices. The SIM card parameters are defined by ISO, ETSI and GSM standards.

SIZE COMPARISON: MINI SIM (2FF) VS MICRO SIM (3FF) VS NANO SIM (4FF)



Mini SIM/2FF
25L x 15W x 0.76H(mm)



Micro SIM/3FF
15L x 12W x 0.76H (mm)

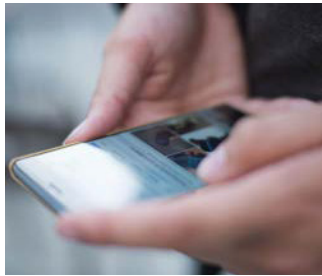


Nano SIM/4FF
12.3L x 8.8W x 0.67H (mm)

*FF = Form Factor

APPLICATIONS AND INDUSTRIES

As the Internet of Things (IoT) market space continues to grow and electronics applications continue to focus on mobility, the need for cellular connections to the internet continues to increase. A SIM card connector is required whenever the wireless connection needs to be made through a cellular network system. As electronic devices become smaller and our world becomes increasingly mobile, the demand for SIM cards in consumer, industrial, and medical applications is on the rise. TE is ready to meet this increased demand as the electronics market continues to mature.



CONSUMER ELECTRONICS

- [Wearable devices](#)
- [Mobile phones](#)
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- [Ultra-portable devices](#)
- Routers
- Portable GSM modems



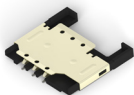
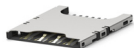

IoT (INTERNET OF THINGS)

- [Fleet telematics](#)
- [Smart transportation](#)
- [EV charging stations](#)
- [Smart health](#)
- [Vehicle trackers](#)
- [Smart meters](#)



PUSH-PUSH TYPE

P/N	Picture	Applicable SIM Size	Height	Length x Width	Description	Features and Benefits	Product Differentiation
1981959-1		Mini SIM 2FF	1.87 mm	23.7 mm x 18.9 mm	Push-push SIM, standard profile	<ul style="list-style-type: none"> • Push to insert, push to eject mechanism provides better card handling for the end user • Push-push function allows convenient SIM card insertion and ejection - helping to minimize card jamming • Card detect switch that senses card removal • The push-push function helps to enable placement in hard-to-reach areas • Error proofing function helps to prevent inserting card in the wrong direction 	-
2174918-1		Mini SIM 2FF	1.4 mm	26 mm x 17 mm	Push-push SIM, super low profile		<ul style="list-style-type: none"> • Low-profile - saves PCB space • Dual slanted contacts provide strong mating force and helps minimize contact jams
2174803-2 2229333-2 2822541-1 Anti-buckling		Micro SIM 3FF	1.27 mm	15.98 mm x 15.1 mm	Push-push SIM, Ultra low profile		<ul style="list-style-type: none"> • Low-profile - saves PCB space • Dual-slanted contacts provide strong mating force and helps minimize contact jams • 2822541-1 adds an anti-buckling feature
2336582-1 Anti-buckling NEW 2490448-1 Anti-buckling		Nano SIM 4FF	1.37 mm	13.72 mm x 13.09 mm	Push-push SIM, Low-Profile Compact Footprint		<ul style="list-style-type: none"> • Low-profile and small footprint - saves PCB space • Anti-crush pin design to protect contact pins from being damaged while inserting SIM card • Two protrusions on the bottom serve as positioning features, increasing stability • Comparison between 2336582-1 and 2490448-1, 2490448-1 has robust structure for entrance of housing and thinner gold plating for contact area.

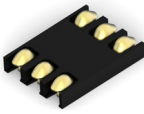

PUSH-PULL TYPE

P/N	Picture	Applicable SIM Size	Height	Length x Width	Description	Features and Benefits	Product Differentiation
1932768-1		Mini SIM 2FF	1.95 mm	16.3 mm x 14.8 mm	Super low profile SIM with flange (big shield)	<ul style="list-style-type: none"> Card guidance feature and card stop feature confirm full insertion, helping to provide proper fixation of the SIM card Card is typically located inside the device shell 	<ul style="list-style-type: none"> Holes under the connector allow for automated testing - helping to reduce in-place cost Shield helps protect against EMI, RF distortion, and card bend Preloaded anti-lifting contacts (contact tip is round) helps to prevent contacts from buckling Can mount components under the connector to help save board space
2199337-5 Anti-buckling		Micro SIM 3FF	1.18 mm	14.1 mm x 13.3 mm	Push-pull SIM, ultra low profile (anti-buckling)	<ul style="list-style-type: none"> Device shell must be opened to extract the card Manual card insertion and extraction Full single clip helps to provide shielding and helps to prevent card bending. This ensures a stable connection with all card types 	<ul style="list-style-type: none"> Low-profile - saves PCB space Contact design prevents buckling in use of a nano SIM card in an adapter Card detect switch that senses card removal
2452808-1		Nano SIM 4FF	1.37 mm	13.72 mm x 13.09 mm	Push-pull SIM, Low-Profile Compact Footprint		<ul style="list-style-type: none"> Low-profile and small footprint - helps to save PCB space Simpler structure Stronger structure due to molding process for housing and contact Solder pins on side Card detect switch that senses card removal

HINGE TYPE

P/N	Picture	Applicable SIM Size	Height	Length x Width	Description	Features and Benefits
<div>NEW</div> 2499165-1		Micro SIM 3FF	1.5 mm	14.9 mm x 15.9 mm	Hinge type SIM	<ul style="list-style-type: none"> • Space saving design • SIM card loads from the top of the connector • Card detect switch that senses card removal (2199165-1 doesn't have detection switch) • Shell openings allow for automated testing - helping to reduce in-place cost • The hinge includes two protrusions to help secure the metal shell
2452796-1		Nano SIM 4FF	1.4 mm	14 mm x 11.54 mm	Hinge type SIM	

5-DIRECTIONAL TYPE

P/N	Picture	Applicable SIM Size	Height	Length x Width	Description	Features and Benefits
2-1705300-8		Mini SIM 2FF	3.5 mm	14 mm x 11.54 mm	5 directional SIM	<ul style="list-style-type: none"> • Allows insertion of SIM card from 5 different directions • Allows expanded design flexibility • SIM card can be fixed with application's mechanical design
1-1705300-5		Mini SIM 2FF	2.2 mm	10 mm x 7.6 mm	5 directional SIM	

FREQUENTLY ASKED QUESTIONS

QUESTION 1

How do I decide which type of SIM connector to choose?

ANSWER 1

The major difference in choosing between SIM connectors depends on the design of the customer device. Push-push or tray type SIM connectors allow users to extract the SIM card from the external portion of the device. Push-pull type, block type, and hinge type connectors require users to open the back shell of the device and manually pull out the SIM card.

QUESTION 2

What is the purpose of an 8 position SIM connector?

ANSWER 2

The extra two positions support an additional function like electronic payment.

QUESTION 3

What is the benefit of dual-slanted contact performance?

ANSWER 3

The dual-slanted design helps to minimize contact jam issues and creates a stronger mating performance, as demonstrated during the drop test.

QUESTION 4

When should I use a micro SIM connector?

ANSWER 4

When the device requires the use of a micro SIM card.

QUESTION 5

What's the scalable height?

ANSWER 5

The scalable height is found when the SIM card connector is scalable by a different P/N, but the connector footprint stays the same. The benefit is enabling the customer to swap the product easier when a design change occurs, thereby helping to reduce the leadtime of TTM (Time To Market), TTV (Time To Value) and design cost.

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